### 7.6mmX7.6mm SUPER FLUX LED LAMP

Part Number: L-7676CSURC-G Hyper Red

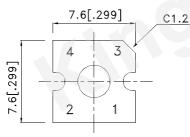
#### **Features**

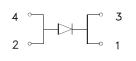
- Super flux output.
- Design for high current operation.
- Outstanding material efficiency.
- Reliable and rugged.
- RoHS compliant.

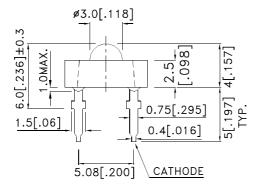
#### Description

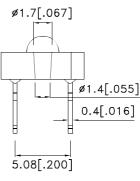
The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

#### **Package Dimensions**









#### Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is ±0.25(0.01") unless otherwise noted.

Lead spacing is measured where the leads emerge from the package.
The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

DATE: APR/05/2013 DRAWN: Y.Liu



#### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Φv (mlm) [2] @ 20mA	Viewing Angle [1]
			Min.	Тур.	Тур.	201/2
L-7676CSURC-G	Hyper Red (AlGaInP)	Water Clear	300	480	*300	70°
			*120	*200	500	

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity/ luminous Flux: +/-15%.LEDs are binned according to their Luminous intensity.
Drive current between 10mA and 30mA are recommended for long term performance.

4. Operation at current below 10mA is not recommended.
\* Luminous intensity/ luminous Flux value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	Hyper Red	645	645		I⊧=20mA	
λD [1]	Dominant Wavelength	Hyper Red	630		nm	I⊧=20mA	
Δλ1/2	Spectral Line Half-width	Hyper Red	22		nm	I⊧=20mA	
С	Capacitance	Hyper Red	45		pF	VF=0V;f=1MHz	
Vf [2]	Forward Voltage	Hyper Red	1.9	2.5	V	I⊧=20mA	
lr	Reverse Current	Hyper Red		10	uA	VR = 5V	

Notes:

1.Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3.Wavelength value is traceable to the CIE127-2007 compliant national standards.

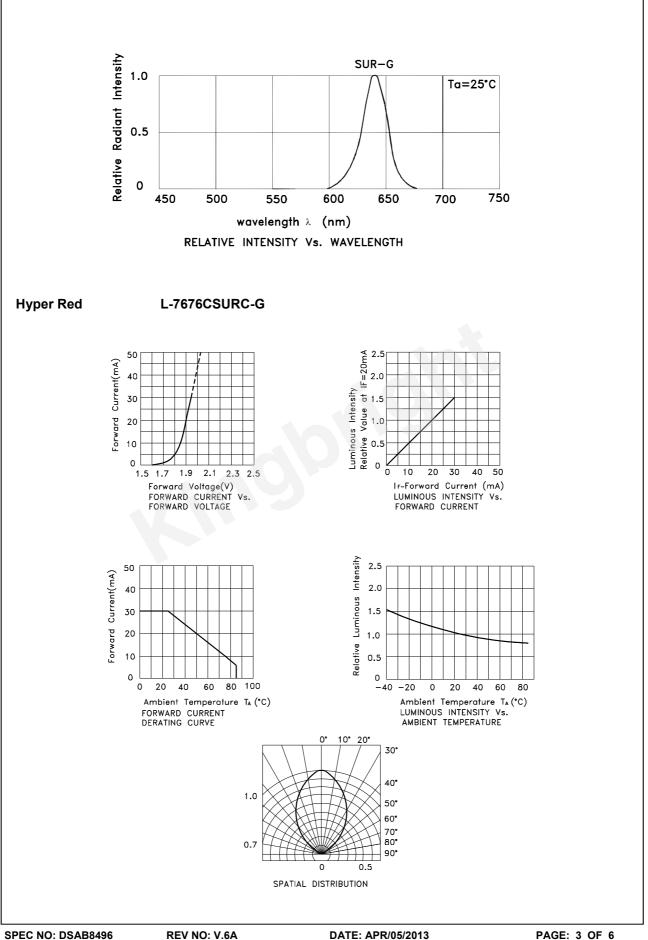
#### Absolute Maximum Ratings at TA=25°C

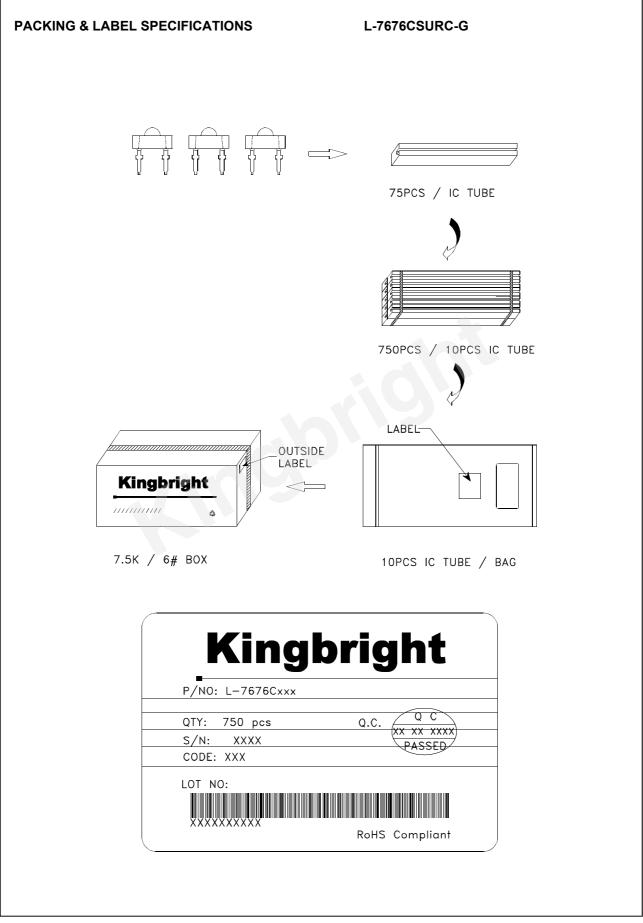
Parameter	Hyper Red	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating/Storage Temperature	-40°C To +85°C			
Lead Solder Temperature [2]	260°C For 3 Seconds			
Lead Solder Temperature [3]	260°C For 5 Seconds			

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

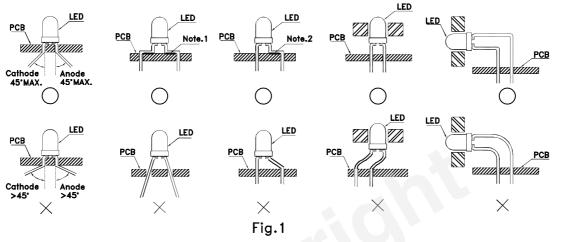
2. 2mm below package base.
3. 5mm below package base.





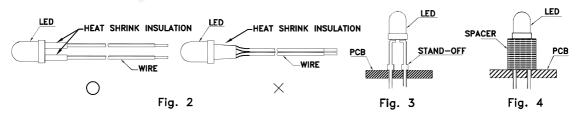
### PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)

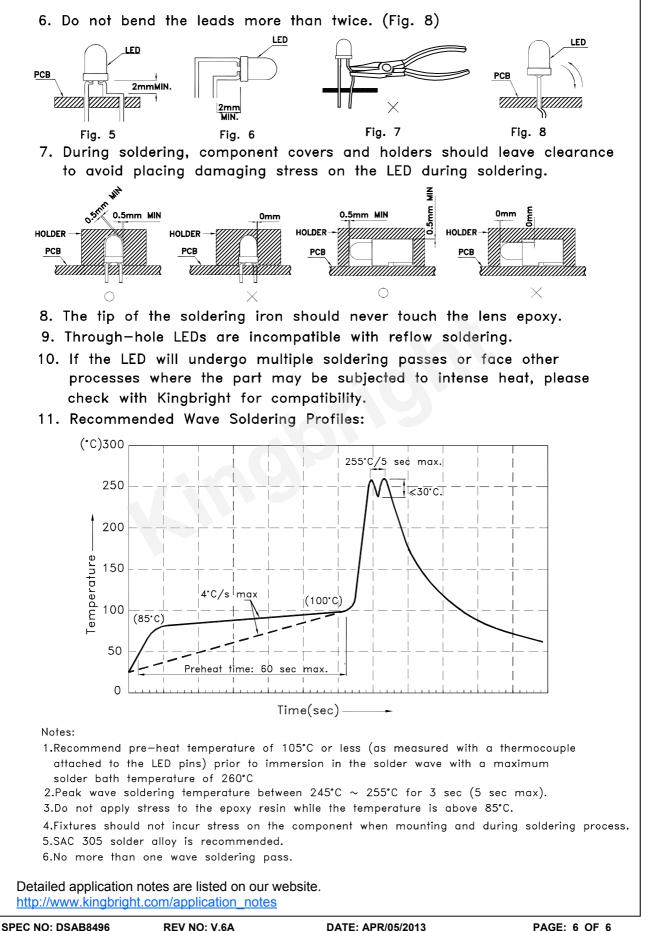


" $\bigcirc$ " Correct mounting method "imes" Incorrect mounting method

- 2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig.2)
- 3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)



APPROVED: WYNEC

REV NO: V.6A CHECKED: Allen Liu DATE: APR/05/2013 DRAWN: Y.Liu